

Appl. No. 10/605,585  
Response dated April 26, 2005  
Reply to Office Action of Jan. 26, 2005

**AMENDMENTS TO THE SPECIFICATION:**

Please amend the title of the invention as follows:

~~--Semiconductor device and method of producing the same--~~

Please amend Paragraph 0017 of the specification as follows:

~~--In view of the above, there exists a need for a method of producing a plate spring~~  
semiconductor device which overcomes the above mentioned problems in the prior art. This invention addresses this need in the prior art as well as other needs, which will become apparent to those skilled in the art from this disclosure.--